

# **SPECIFICATIONS**

#### Mechanical

Mating Force: 20kgf max. Unmating Force: 2.2kgf min.

Durability: 30 Cycles

#### **Electrical**

Current Rating: 0.5A max.per contact

Contact Resistance:  $55m\Omega$  max.(Initial),  $75m\Omega$  max.(After) Dielectrical Withstanding Voltage: 200 VAC for 1 minute Insulation Resistance: 100 mega ohms min. at 500 VDC

# **Physical**

Housing: LCP Black Color Contact: Copper Alloy

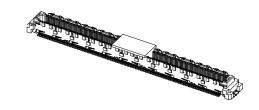
Plating: 6u" min. Gold Plating on Contact Area

Metal Ear: Copper Alloy

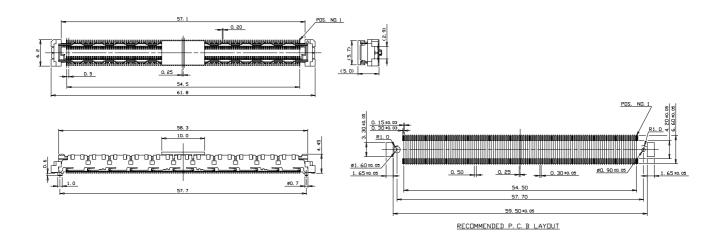
**Operating Temperature:** -40  $\mathcal C$  to +85  $\mathcal C$ 

### **Board to Board Connector**

QT00 Series 0.5mm Pitch For High Speed Application Mated with QT01 Series



#### **DRAWING**



# ORDERING INFORMATION

